

ALPHA[®] EF-6100

Low Solids, High Reliability, Alcohol Based Wave Soldering Flux for Lead-Free and Tin-Lead Applications

DESCRIPTION

ALPHA EF-6100 was specifically developed to deliver high reliability and excellent soldering performance combined with outstanding board cosmetics and pin-testability. **ALPHA EF-6100** exhibits a low tendency for solder ball generation over a wide variety of solder masks during wave soldering and Selective Soldering operations. **ALPHA EF-6100** should be considered for use by any assembler who has board designs which require high reliability, good through-hole-fill, reduced component bridging and reduced skips.

ALPHA EF-6100 is a high-reliability, IPC, Bellcore, and JIS compliant, low solids, no-clean flux. It has been designed with a wide thermal process window enabling best-in-class productivity with lead-free wave soldering applications and is an excellent choice for remaining tin-lead production lines. **ALPHA EF-6100** is formulated with a proprietary mixture of organic activators to give more thermal stability, thereby reducing the occurrence of solder bridging during lead-free dual wave soldering.

READ ENTIRE TECHNICAL DATA SHEET BEFORE USING THIS PRODUCT

FEATURES & BENEFITS

- Exhibits exceptional electrical reliability for a low-solids wave soldering flux. Complies with IPC-J-STD-004 SIR, Bellcore SIR, Bellcore ECM, JIS ECM, and JIS SIR.
- Thermally stable activators provide minimized solder bridging in a low-solids, no-clean flux for wave soldering and Selective Soldering in lead-free and tin-lead applications.
- Reduces the surface tension between solder mask and solder to resist solder ball formation
- Very low level of non-tacky residue to reduce interference with pin testing and exhibit no visible residue.





APPLICATION GUIDELINES

Preparation: To maintain consistent soldering performance and electrical reliability, it is important to begin the process with circuit boards and components that meet established requirements for solderability and ionic cleanliness. It is suggested that assemblers establish specifications on these items with their suppliers and that suppliers provide Certificates of Analysis with shipments and/or assemblers perform incoming inspection. A common specification for the onic cleanliness of incoming boards and components is $5\mu g/in2$ (0.77 $\mu g/cm^2$) maximum, as measured by an ionic contamination tester.

Care should be taken in handling the circuit boards throughout the process. Boards should always be held at the edges. The use of clean, lint-free gloves is also recommended. When switching from one flux to another, the flux reservoir, flux tank and lines of the spray fluxer assembly should be purged with IPA.

Conveyors, fingers and pallets should be cleaned periodically with, IPA or other commercial Solvent Cleaners to eliminate residues on the assembly edges.

Flux Application: ALPHA EF-6100 is formulated to be applied by spray methods. A uniform coating of flux is essential to successful soldering. When spray fluxing, the uniformity of the coating can be visually checked by running a piece of pH sensitive paper matching the footprint of the assembly over the spray fluxer.

General Guidelines for Machine Settings			
Operating Parameter SAC305 / SACX0307		63Sn37Pb	
Flux application	Spray	Spray	
Amount of Flux Applied (Single	1200 to 1800 μg/in²	1000 to 1400 µg/in ²	
Wave)	(190 to 280 μ g/cm ²) of solids	(155 to 220 $\mu g/cm^2)$ of solids	
Amount of Flux Applied (Dual	1600 to 2000 μg/in²	1500 to 1800 μg/in²	
Wave)	(250 to 310 μ g/cm ²) of solids	(230 to 280 $\mu g/cm^2)$ of solids	
Top-Side Preheat Temperature	90 to 120 °C (194 to 248 °F)	75 to 100 °C (167 to 212 °F)	
Bottom side Preheat	About 35 °C (95 °F)	About 35 °C (95 °F)	
Temperature	higher than topside	higher than topside	
Maximum Ramp Rate of Topside Temperature (to avoid component damage)	2 °C/sec maximum	2 °C/sec maximum	
Conveyor Angle	4 to 7° (6° typical)	4 to 7° (6° typical)	
Contact Speed	3 to 6 ft/min (0.9 to 1.8 m/min)	3 to 6 ft/min (0.9 to 1.8 m/min)	





General Guidelines for Machine Settings				
Operating Parameter	SAC305 / SACX0307	63Sn37Pb		
Contact Time in the Solder (includes Chip Wave and Primary Wave)	1.5 to 3.5 sec (2.5 to 3 sec most common)	1.5 to 3.5 sec (2.5 to 3 sec most common)		
Solder Pot Temperature	255 to 265 °C (491 to 509 °F) 240 to 250 °C (464 to 482 °F)			
These are general guidelines which have proven to yield excellent results; however, depending upon your equipment, components, and circuit boards, your optimal settings may be different. In order to optimize your process, it is recommended to perform a design experiment, optimizing the most important variables (amount of flux applied, conveyor speed,				

Flux Solids Control: As with any flux with less than 5% solids content, specific gravity is not an effective measurement for assessing and controlling the solids content. Monitoring and controlling the acid number is recommended for maintaining the solids content. The acid number should be controlled to between 22.7 and 25.1, Alpha's Flux Solids Control Kit #3, a digital titrator, is suggested. Request Alpha's Reference Bulletin for details on the kit and titration procedure.

topside preheat temperature, solder pot temperature and board orientation).

Residue Removal: ALPHA EF-6100 is a no-clean flux and the residues are designed to be left on the board. However, if desired, ALPHA EF-6100 residues can be easily removed with various cleaning products including ALPHA BC-2200 aqueous board cleaner, ALPHA 2110 saponifier, IPA or commercial solvent cleaners.

Touch-Up/Rework: Use of the Cleanline Write Flux Applicator with ALPHA NR-205 flux and ALPHA Telecore Series cored solder is recommended for hand soldering applications.





TECHNICAL DATA

Item	Typical Values	Item	Typical Values
Appearance	Clear, colorless to pale yellow liquid	Flash Point (T.C.C.)	12 °C (53 °F)
Solids Content, %wt/wt	3.8%	Recommended Thinner	ALPHA 425
Specific Gravity @ 25 °C (77 °F)	0.794 ± 0.003	Shelf Life (from Date of Mfg.)	360 days
Acid Number, mg KOH/g	23.9 ± 1.2	IPC J-STD-004 Designation	ORL0
pH (5% aqueous solution)	3.3	Packaging Size	1, 5 and 55 gallons
Pounds per Gallon	6.6		

CORROSION & ELECTRICAL TESTING

Corrosion Test

Test	Requirement	Results
Silver Chromate Paper	No Detection of Halides	PASS
Copper Mirror Test	No Complete Removal of Copper	PASS
Copper Corrosion Test	No Evidence of Corrosion	PASS

IPC J-STD-004 Surface Insulation Resistance (All values in ohms)

Test	Requirement	Results	
"Comb-Down" Un-cleaned	1.0 x 10 ⁸ minimum	2.3 x 10 ¹⁰	
"Comb-Up" Un-cleaned	1.0 x 10 ⁸ minimum	2.2 x 10 ¹⁰	
Control Boards	2.0 x 10 ⁸ minimum	2.3 x 10 ¹⁰	
Test Condition (per IPC J-STD-004): 85 °C / 85% RH / 7 days / -50V, measurements @ 100V / IPC B-24 Board (0.4mm lines, 0.5mm spacing)			





Bellcore Surface Insulation Resistance (All values in ohms)

Test	Requirement	Results	
"Comb-Down" Un-cleaned	1.0 x 10 ¹¹ minimum	1.1 x 10 ¹²	
"Comb-Up" Un-cleaned	1.0 x 10 ¹¹ minimum	3.6 x 10 ¹¹	
Control Boards	2.0 x 10 ¹¹ minimum	7.8 x 10 ¹¹	
Test Condition (per Bellcore GR 78-CORE, Issue 1): 48V, measurements @ 100V / 25mil lines, 50mil spacing			

JIS Surface Insulation Resistance (All values in ohms)

Test	Condition	Requirement	Control	Result
Initial				
"Comb-Down"	Ambient	1.0 x 10 ¹¹ minimum	5.2 x 10 ¹¹	3.4 x 10 ¹¹
Un-cleaned				
After 168 Hours				
"Comb-Down"	40 °C / 93% RH	1.0 x 10 ¹⁰ minimum	1.5 x 10 ¹¹	8.8 x 10 ¹⁰
Un-cleaned				
Recovered				
"Comb-Down"	35 °C / 85% RH, 5 days	1.0 x 10 ¹¹ minimum	4.7 x 10 ¹¹	2.8 x 10 ¹¹
Un-cleaned				
Initial "Comb-Up"	Ambiont	1.0×10^{11} minimum	5 2 v 10 ¹¹	2.5×10^{11}
Un-cleaned	Ampient		J.Z X 10	2.5 X 10
After 168 Hours				
"Comb-Up"	40 °C / 93% RH	1.0 x 10 ¹⁰ minimum	1.5 x 10 ¹¹	3.2 x 10 ¹⁰
Un-cleaned				
Recovered				
"Comb-Up"	35 °C / 85% RH, 5 days	1.0 x 10 ¹¹ minimum	4.7 x 10 ¹¹	1.7 x 10 ¹¹
Un-cleaned				
Test Condition (per JIS Standard): measurements @ 100V / JIS Boards (0.32mm lines, 0.32mm spacing, same as IPC B-25 Boards)				





Bellcore Electrochemical Migration Resistance

Test	SIR (Initial)	SIR (Final)	Requirement	Result	Visual Result
"Comb-Up" Un-cleaned	9.3 x 10 ⁹	2.3 x 10 ¹¹	SIR (Initial) / SIR (Final) < 10	PASS	PASS
"Comb-Down" Un-cleaned 7.2×10^9 6.6×10^9 SIR (Initial) / SIR (Final) < 10PASSPASS			PASS		
Test Condition (per Bellcore GR 78-CORE, Issue 1): 65 °C / 85% RH / 500 Hours / 10V, measurement @100V / IPC B-25 B Pattern (12.5mil lines, 12.5mil spacing)					

JIS Standard Electromigration

Electrical and visual requirements of JIS standards: PASS

Geometric Mean SIR value: 4.9 x 1010 ohm (@85 deg °C / 85% RH / 48VDC / 1000hrs)

Migration: No evidence of electrochemical migration

RECYCLING SERVICES

We provide safe and efficient recycling services to help companies meet their environmental and legislative requirements and at the same time, maximize the value of their waste streams.

Our service collects solder dross, solder scrap, and various forms of solder paste waste. Please contact your local sales representative for recycling capabilities in your area or <u>link here</u>.









SAFETY & WARNING

It is recommended that the company/operator read and review the Safety Data Sheets for the appropriate health and safety warnings before use. **Safety Data Sheets are available at MacdermidAlpha.com/assembly-solutions/knowledge-base.**

CONTACT INFORMATION

To confirm this document is the most recent version, please contact Assembly@MacDermidAlpha.com

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE . Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588

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